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April 1988 Revised September 2000

#### 74F377

## Octal D-Type Flip-Flop with Clock Enable

#### **General Description**

The 74F377 has eight edge-triggered, D-type flip-flops with individual D inputs and Q outputs. The common buffered Clock (CP) input loads all flip-flops simultaneously, when the Clock Enable  $(\overline{\text{CE}})$  is LOW.

The register is fully edge-triggered. The state of each D input, one setup time before the LOW-to-HIGH clock transition, is transferred to the corresponding flip-flop's Q output. The  $\overline{\text{CE}}$  input must be stable only one setup time prior to the LOW-to-HIGH clock transition for predictable operation.

#### **Features**

- Ideal for addressable register applications
- Clock enable for address and data synchronization applications
- Eight edge-triggered D-type flip-flops
- Buffered common clock
- See 74F273 for master reset version
- See 74F373 for transparent latch version
- See 74F374 for 3-STATE version

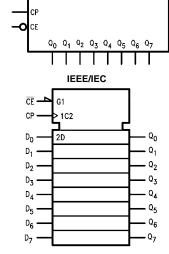
#### **Ordering Code:**

Order Number	Package Number	Package Description
74F377SC	M20B	20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300 Wide
74F377SJ	M20D	20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
74F377PC	N20A	20-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide

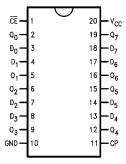
Devices also available in Tape and Reel. Specify by appending the suffix letter "X" tot he ordering code.

D<sub>1</sub> D<sub>2</sub> D<sub>3</sub> D<sub>4</sub> D<sub>5</sub> D<sub>6</sub> D<sub>7</sub>

#### **Logic Symbols**



#### **Connection Diagram**



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DS009525

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## **Unit Loading/Fan Out**

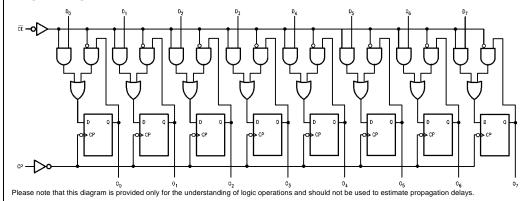
Din Names	Description	U.L.	Input I <sub>IH</sub> /I <sub>IL</sub>	
Pin Names	Description	HIGH/LOW	Output I <sub>OH</sub> /I <sub>OL</sub>	
D <sub>0</sub> –D <sub>7</sub>	Data Inputs	1.0/1.0	20 μA/-0.6 mA	
CE	Clock Enable (Active LOW)	1.0/1.0	20 μA/–0.6 mA	
СР	Clock Pulse Input	1.0/1.0	20 μA/-0.6 mA	
Q <sub>0</sub> –Q <sub>7</sub>	Data Outputs	50/33.3	−1 mA/20 mA	

#### **Mode Select-Function Table**

_ ,, ., .		Inputs					
Operating Mode	СР	CE	D <sub>n</sub>	Q <sub>n</sub>			
Load "1"	~	I	h	Н			
Load "0"	~	ı	I	L			
Hold	~	h	Х	No Change			
(Do Nothing)	Х	Н	Х	No Change			
H = HIGH Voltage Level h = HIGH Voltage Level one setup time prior to the LOW- L = LOW Voltage Level I = LOW Voltage Level one setup time prior to the LOW- X = Inmaterial = LOW to-HIGH Clock Transition							

- = LOW-to-HIGH Clock Transition

#### **Logic Diagram**



#### Absolute Maximum Ratings(Note 1)

## Recommended Operating Conditions

 $\begin{array}{ll} \mbox{Storage Temperature} & -65^{\circ}\mbox{C to } +150^{\circ}\mbox{C} \\ \mbox{Ambient Temperature under Bias} & -55^{\circ}\mbox{C to } +125^{\circ}\mbox{C} \\ \end{array}$ 

 $\begin{array}{lll} \mbox{Junction Temperature under Bias} & -55^{\circ}\mbox{C to } +150^{\circ}\mbox{C} \\ \mbox{V}_{\mbox{CC}} \mbox{ Pin Potential to Ground Pin} & -0.5\mbox{V to } +7.0\mbox{V} \\ \mbox{Input Voltage (Note 2)} & -0.5\mbox{V to } +7.0\mbox{V} \end{array}$ 

Input Current (Note 2) -30 mA to +5.0 mA Voltage Applied to Output

in HIGH State (with  $V_{CC} = 0V$ )

 $\begin{array}{lll} \mbox{Standard Output} & -0.5 \mbox{V to V}_{\mbox{CC}} \\ \mbox{3-STATE Output} & -0.5 \mbox{V to } +5.5 \mbox{V} \end{array}$ 

Current Applied to Output

in LOW State (Max)  ${\rm twice\ the\ rated\ I_{OL}\ (mA)}$  ESD Last Passing Voltage (Min)  ${\rm 4000V}$ 

Free Air Ambient Temperature  $0^{\circ}\text{C} \text{ to } +70^{\circ}\text{C}$  Supply Voltage +4.5V to +5.5V

**Note 1:** Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Note 2: Either voltage limit or current limit is sufficient to protect inputs.

#### **DC Electrical Characteristics**

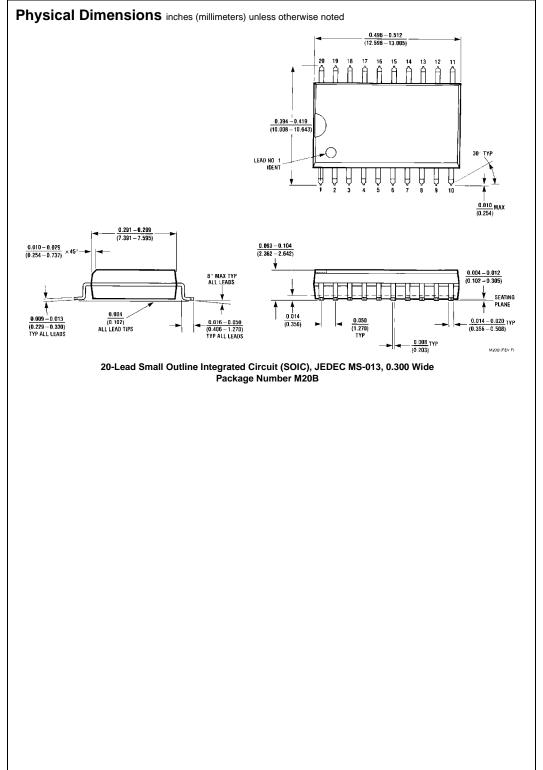
Symbol	Parameter	Min	Тур	Max	Units	v <sub>cc</sub>	Conditions
V <sub>IH</sub>	Input HIGH Voltage	2.0			V		Recognized as a HIGH Signal
V <sub>IL</sub>	Input LOW Voltage			0.8	V		Recognized as a LOW Signal
V <sub>CD</sub>	Input Clamp Diode Voltage			-1.2	V	Min	I <sub>IN</sub> = -18 mA
V <sub>OH</sub>	Output HIGH 10% V <sub>CC</sub>	2.5			V	Min	I <sub>OH</sub> = -1 mA
	Voltage 5% V <sub>CC</sub>	2.7			V	IVIIII	$I_{OH} = -1 \text{ mA}$
V <sub>OL</sub>	Output LOW Voltage 10% V <sub>CC</sub>			0.5	V	Min	I <sub>OL</sub> = 20 mA
I <sub>IH</sub>	Input HIGH Current			5.0	μΑ	Max	V <sub>IN</sub> = 2.7V
I <sub>BVI</sub>	Input HIGH Current			7.0	μА	Max	V <sub>IN</sub> = 7.0V
	Breakdown Test			7.0	μΛ	IVIAX	V IN - 1.0V
I <sub>IL</sub>	Input LOW Current			-0.6	mA	Max	V <sub>IN</sub> = 0.5V
Ios	Output Short-Circuit Current	-60		-150	mA	Max	V <sub>OUT</sub> = 0V
I <sub>CEX</sub>	Output HIGH Leakage Current			50	μΑ	Max	$V_{OUT} = V_{CC}$
V <sub>ID</sub>	Input Leakage	4.75			V	0.0	I <sub>ID</sub> = 1.9 μA
	Test	4.73			V	0.0	All Other Pins Grounded
I <sub>OD</sub>	Output Leakage			3.75	^	0.0	V <sub>IOD</sub> = 150 mV
	Circuit Current				μА		All Other Pins Grounded
Іссн	Power Supply Current		35	46	mA	Max	CP =
I <sub>CCL</sub>			44	56	IIIA	IVIAX	$D_n = \overline{MR} = HIGH$

## **AC Electrical Characteristics**

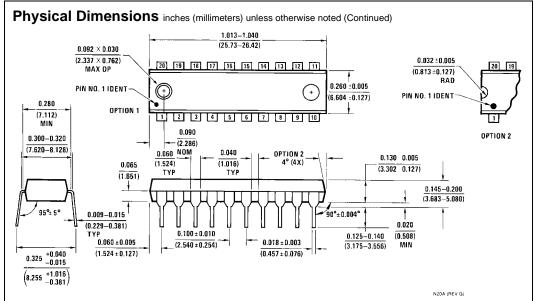
Symbol	Parameter	$T_{A} = +25^{\circ}C$ $V_{CC} = +5.0V$ $C_{L} = 50 \text{ pF}$			$T_{A} = -55 ^{\circ} C \text{ to } +125 ^{\circ} C$ $V_{CC} = +5.0 V$ $C_{L} = 50 \text{ pF}$		$T_A = 0$ °C to +70°C $V_{CC} = +5.0V$ $C_L = 50 \text{ pF}$		Units
		Min	Тур	Max	Min	Max	Min	Max	
f <sub>MAX</sub>	Maximum Clock Frequency	130			85		105		MHz
t <sub>PLH</sub>	Propagation Delay	3.0		7.0	2.0	8.5	2.5	7.5	20
t <sub>PHL</sub>	CP to Q <sub>n</sub>	4.0		9.0	3.0	10.5	3.5	9.0	ns

## **AC Operating Requirements**

		$T_A = +25^{\circ}C$ $V_{CC} = +5.0V$		$T_A = -55^{\circ}C$ to $+125^{\circ}C$ $V_{CC} = +5.0V$		$T_A = 0$ °C to +70°C $V_{CC} = +5.0V$		Units	
Symbol	Parameter								
		Min	Max	Min	Max	Min	Max		
t <sub>S</sub> (H)	Setup Time, HIGH or LOW	3.0		3.5		3.0		no	
t <sub>S</sub> (L)	D <sub>n</sub> to CP	3.5		4.0		3.5		ns	
t <sub>H</sub> (H)	Hold Time, HIGH or LOW	0.5		1.0		0.5			
t <sub>H</sub> (L)	D <sub>n</sub> to CP	1.0		1.0		1.0		ns	
t <sub>S</sub> (H)	Setup Time, HIGH or LOW	4.1		4.0		4.1			
t <sub>S</sub> (L)	CE to CP	3.5		5.0		4.0		ns	
t <sub>H</sub> (H)	Hold Time, HIGH to LOW	0.5		1.5		0.5			
$t_H(L)$	CE to CP	2.0		2.5		2.0		ns	
t <sub>W</sub> (H)	Clock Pulse Width,	6.0		5.0		6.0		ns	
$t_W(L)$	HIGH or LOW	6.0		5.0		6.0		115	



## Physical Dimensions inches (millimeters) unless otherwise noted (Continued) 2.6±0.10 0.40 TYP --A-5.01 TYP 5.3±0.10 9.27 TYP 7.8 -B-3.9 ○ 0.2 C B A ALL LEAD TIPS 10 PIN #1 IDENT.-- 0.6 TYP 1.27 TYP -LAND PATTERN RECOMMENDATION ALL LEAD TIPS SEE DETAIL A 0.1 C 2.1 MAX. 1.8±0.1 0.15±0.05 0.15-0.25 -1.27 TYP 0.35-0.51 **♦** 0.12 **⋈** C A DIMENSIONS ARE IN MILLIMETERS GAGE PLANE NOTES: 0.25 A. CONFORMS TO EIAJ EDR-7320 REGISTRATION, ESTABLISHED IN DECEMBER, 1998. B. DIMENSIONS ARE IN MILLIMETERS. C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS. 0.60±0.15-SEATING PLANE 1.25 -M20DRevB1 DETAIL A 20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide Package Number M20D



20-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide Package Number N20A

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